Renesas Electronics America Inc - M30280F6HP#U7B Datasheet

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	M16C/60
Core Size	16-Bit
Speed	20MHz
Connectivity	I²C, IEBus, SIO, UART/USART
Peripherals	DMA, POR, PWM, Voltage Detect, WDT
Number of I/O	71
Program Memory Size	48KB (48K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 24x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-LQFP
Supplier Device Package	80-LQFP (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/m30280f6hp-u7b

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1. Overview

The M16C/28 Group (M16C/28 and M16C/28B) MCU are single-chip control MCU, fabricated using high-performance silicon gate CMOS technology with the M16C/60 series CPU core. The M16C/28 Group (M16C/28 and M16C/28B) are housed in 64-pin and 80-pin plastic molded LQFP packages and also in 85-pin plastic molded TFLGA (Thin Fine Pitch Land Grid Array) package. With a 1-Mbyte address space, this MCU combines advanced instruction manipulation capabilities to process complex instructions by less bytes and execute instructions at higher speed. It includes a multiplier and DMAC adequate for office automation, communication devices and other high-speed processing applications.

The M16C/28 has Normal-ver., T-ver., and V-ver.. The M16C/28B has Normal-ver. only.

This hardware manual describes the Normal-ver. only. Please contact Renesas Technology Corp. for T-ver./V-ver. information.

1.1 Applications

Audio, cameras, office equipment, communication equipment, portable equipment, home appliances (in-verter solution), motor control, industrial equipment, etc.

1.3 Block Diagram

Figure 1.1 is a block diagram of the M16C/28 Group (M16C/28, M16C/28B), 80-pin and 85-pin package.
Figure 1.2 is a block diagram of the M16C/28 Group (M16C/28, M16C/28B), 64-pin package.

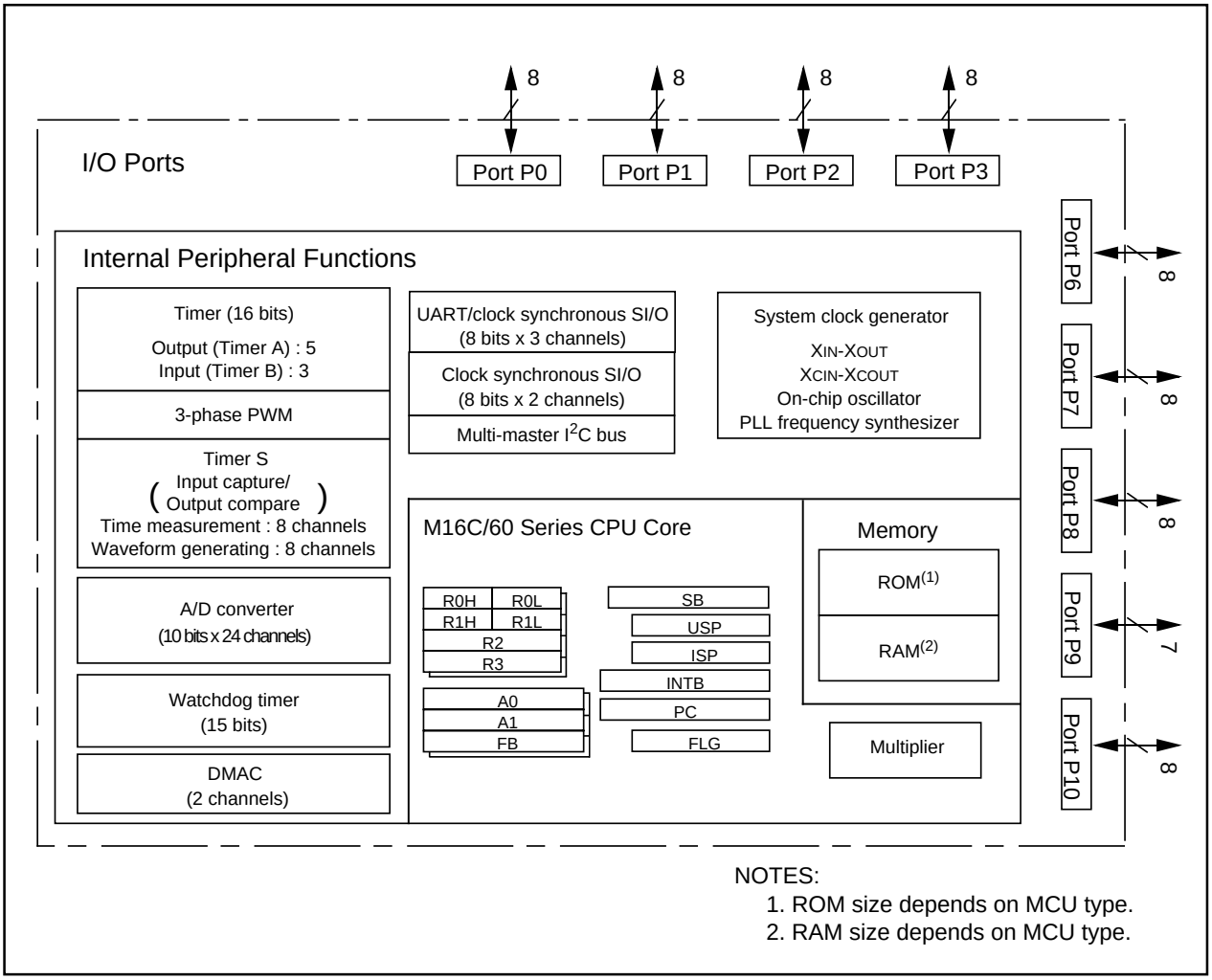


Figure 1.1 M16C/28 Group (M16C/28, M16C/28B), 80-Pin/85-Pin Block Diagram

Table 1.5 Product Code (Flash Memory-ver.) - M16C/28 Normal-ver., 64-Pin(1)/80-Pin(1)/85-Pin Package

Product Code	Package	Internal ROM (User Program Space)		Internal ROM (Data Space)		Operating Ambient Temperature
		Program and Erase Endurance	Temperature Range	Program and Erase Endurance	Temperature Range	
U3	Lead free	100	0 to 60°C	100	0 to 60°C	-40 to 85°C
U5						-20 to 85°C
U7		1,000		10,000	-40 to 85°C	-40 to 85°C
U9					-20 to 85°C	-20 to 85°C

NOTE:
1. The lead contained products, D3, D5, D7 and D9, are put together with U3, U5, U7 and U9 respectively. Lead-free (Sn-Ag-Cu plating) products can be mounted by both conventional Sn-Pb paste and Lead-free paste.

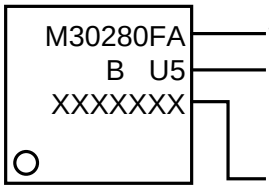
Table 1.6 Product Code (Flash Memory-ver.) - M16C/28B Normal-ver., 64-Pin/85-Pin Package

Product Code	Package	Internal ROM (User Program Space)		Internal ROM (Data Space)		Operating Ambient Temperature
		Program and Erase Endurance	Temperature Range	Program and Erase Endurance	Temperature Range	
U7	Lead-free	1,000	0 to 60°C	10,000	-40 to 85°C	-40 to 85°C

Table 1.7 Product Code (Mask ROM ver.) - M16C/28B Normal-ver., 64-Pin/80-Pin/85-Pin Package

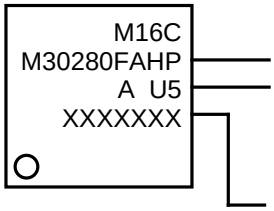
Product Code	Package	Operating Ambient Temperature
U3	Lead-free	-40 to 85°C
U5		-20 to 85°C

(1) Flash Memory Version, PTLG0085JB-A (85F0G), Normal-ver.



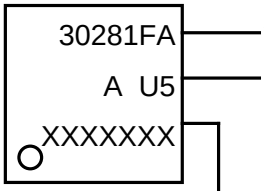
Type No. M30280FAWG
Chip version and product code
B : Chip version.
The first edition is shown to be blank and continues with A, B, and C.
U5 : Product code. (See **Table 1.5**)
Date code seven digits
Manufacturing management code

(2) Flash Memory Version, PLQP0080KB-A (80P6Q-A), Normal-ver.



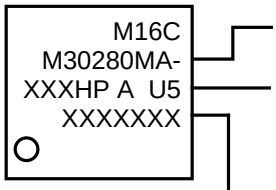
Type No. M30280FAHP
Chip version and product code
A : Chip version and product code(1)
The first edition is shown to be blank and continues with A, B and C.
U5 : Product code. (**Table 1.4**)
Date code seven digits
Manufacturing management code

(3) Flash Memory Version, PLQP0064KB-A (64P6Q-A), Normal-ver.



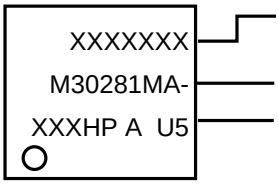
Type No. M30281FAHP
Chip version and product code
A : Chip version and product code(1)
The first edition is shown to be blank and continues with A, B and C.
U5 : Product code. (**Table 1.4**)
Date code seven digits
Manufacturing management code

(4) Mask ROM Version, PLQP0080KB-A (80P6Q-A), Normal-ver.



Type No. M30280MAHP
Chip version and product code
XXX : ROM No.
A : Chip version and product code(1)
The first edition is shown to be blank and continues with A, B and C.
U5 : Product code. (**Table 1.6**)
Date code seven digits
Manufacturing management code

(5) Mask ROM Version, PLQP0064-KB-A (64P6Q-A), Normal-ver.



Date code seven digits
Manufacturing management code
Type No. M30281MAHP
Chip version and product code
XXX: ROM No.
A : Chip version and product code(1)
The first edition is shown to be blank and continues with A, B and C.
U5 : Product code. (**Table 1.6**)

NOTES:
1. The following functinos are not available in the first version and version A products.
-Delay trigger mode 0 of A/D conversion
-Delay trigger mode 1 of A/D conversion

Figure 1.4 Marking Diagram-M16C/28 Normal-ver.

Table 1.8 Pin Characteristics for 85-pin Package (continued)

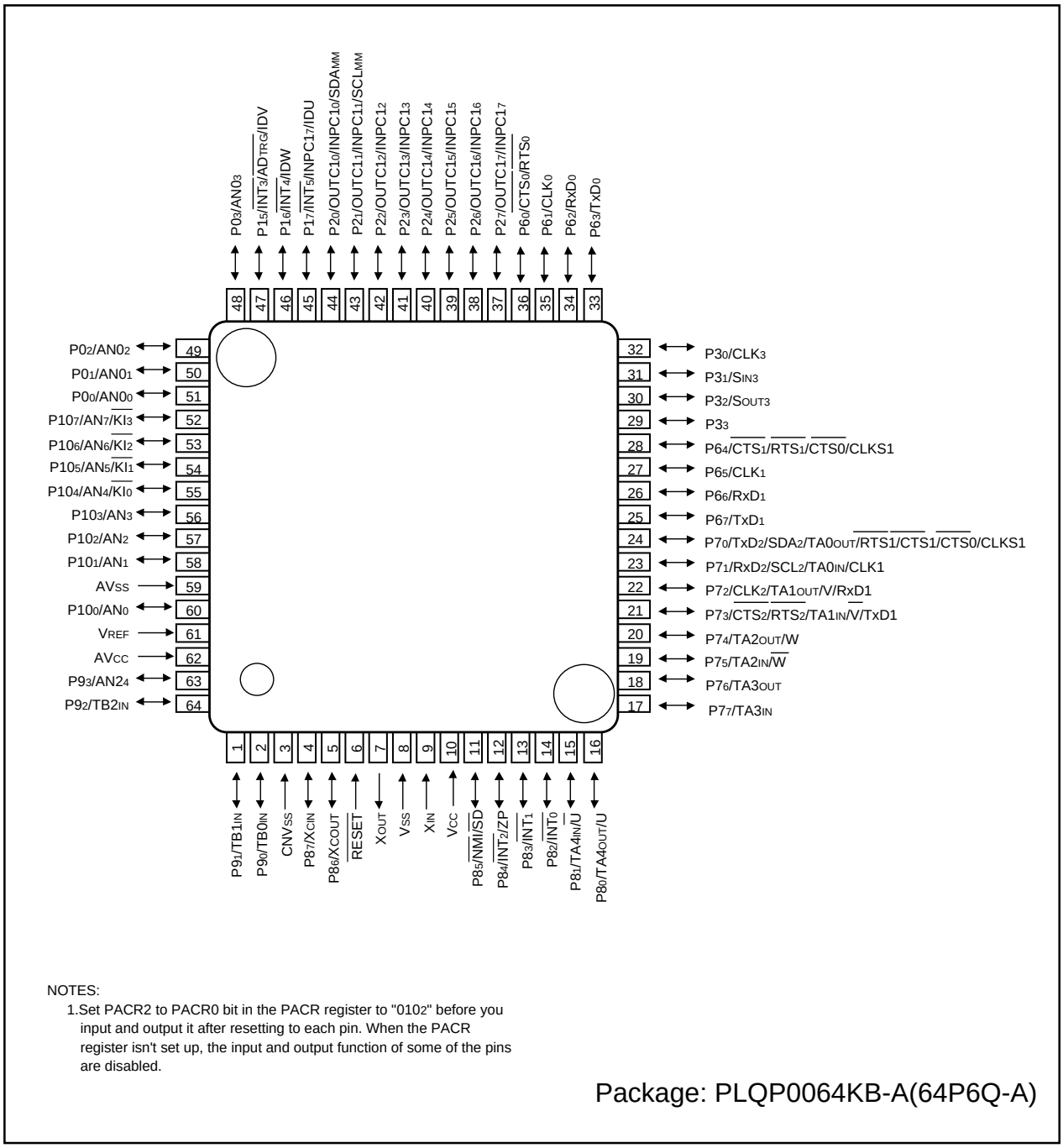
Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART Pin	Multi-master I²C bus Pin	Analog Pin	PLQP0080KB-A Pin Number
E8		P15	$\overline{INT3}$	IDV				$\overline{ADTRG}$	54
E9		P16	$\overline{INT4}$	IDW					53
E10		P17	$\overline{INT5}$	IDU	INPC17				52
F1	Vcc								13
F2	Vcc								13
F3		P85	$\overline{NMI}$	$\overline{SD}$					14
F8	Vss(1)								(11)
F9		P20			OUTC10 / INPC10		SDAMM		51
F10		P21			OUTC11 / INPC11		SCLMM		50
G1		P84	$\overline{INT2}$	ZP					15
G2		P83	$\overline{INT1}$						16
G3		P82	$\overline{INT0}$						17
G8		P22			OUTC12 / INPC12				49
G9		P23			OUTC13 / INPC13				48
G10		P24			OUTC14 / INPC14				47
H1		P81		TA4IN / $\overline{U}$					18
H2		P80		TA4OUT / U					19
H3		P71		TA0IN		RXD2 / SCL2 / CLK1			26
H4		P66				RXD1			29
H5	Vss(1)								(11)
H6		P35							34
H7		P32				SOUT3			37
H8		P25			OUTC15 / INPC15				46
H9		P26			OUTC16 / INPC16				45
H10		P27			OUTC17 / INPC17				44
J1		P76		TA3OUT					21
J2		P74		TA2OUT / W					23
J3		P72		TA1OUT / V		CLK2 / RXD1			25
J4		P67				TXD1			28
J5		P64				$\overline{RTS1}$ / $\overline{CTS1}$/ $\overline{CTS0}$ / CLKS1			31
J6		P36							33
J7		P33							36
J8		P62				RXD0			41
J9		P60				$\overline{RTS0}$ / $\overline{CTS0}$			43
J10		P61				CLK0			42
K1		P77		TA3IN					20
K2		P75		TA2IN / $\overline{W}$					22
K3		P73		TA1IN / $\overline{V}$		$\overline{CTS2}$ / $\overline{RTS2}$ / $\overline{TXD1}$			24
K4		P70		TA0OUT		$\overline{TXD2}$ / $\overline{SDA2}$ / $\overline{RTS1}$ / $\overline{CTS1}$ / $\overline{CTS0}$ / $\overline{CLKS1}$			27
K5		P65				CLK1			30
K6		P37							32
K7		P34							35
K8		P63				TXD0			40
K9		P30				CLK3			39
K10		P31				SIN3			38

Table 1.9 Pin Characteristics for 80-Pin Package

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART Pin	Multi-master I^2C bus Pin	Analog Pin
1		$P9_5$				CLK_4		$AN2_5$
2		$P9_3$						$AN2_4$
3		$P9_2$		TB_{2IN}				
4		$P9_1$		TB_{1IN}				
5		$P9_0$		TB_{0IN}				
6	CNVss							
7	X_{CIN}	$P8_7$						
8	X_{COUT}	$P8_6$						
9	$\overline{RESET}$							
10	X_{OUT}							
11	Vss							
12	X_{IN}							
13	Vcc							
14		$P8_5$	$\overline{NMI}$	$\overline{SD}$				
15		$P8_4$	$\overline{INT_2}$	ZP				
16		$P8_3$	$\overline{INT_1}$					
17		$P8_2$	$\overline{INT_0}$					
18		$P8_1$		TA_{4IN} / $\overline{U}$				
19		$P8_0$		TA_{4OUT} / U				
20		$P7_7$		TA_{3IN}				
21		$P7_6$		TA_{3OUT}				
22		$P7_5$		TA_{2IN} / $\overline{W}$				
23		$P7_4$		TA_{2OUT} / W				
24		$P7_3$		TA_{1IN} / $\overline{V}$		$\overline{CTS_2}$ / $\overline{RTS_2}$ / TxD_1		
25		$P7_2$		TA_{1OUT} / V		CLK_2 / RxD_1		
26		$P7_1$		TA_{0IN}		RxD_2 / SCL_2 / CLK_1		
27		$P7_0$		TA_{0OUT}		TxD_2 / SDA_2 / $\overline{RTS_1}$ / $\overline{CTS_1}$ / $\overline{CTS_0}$ / $CLKS_1$		
28		$P6_7$				TxD_1		
29		$P6_6$				RxD_1		
30		$P6_5$				CLK_1		
31		$P6_4$				RTS_1 / $\overline{CTS_1}$/ $\overline{CTS_0}$ / $CLKS_1$		
32		$P3_7$						
33		$P3_6$						
34		$P3_5$						
35		$P3_4$						
36		$P3_3$						
37		$P3_2$				$SOUT_3$		
38		$P3_1$				SIN_3		
39		$P3_0$				CLK_3		
40		$P6_3$				TxD_0		

Table 1.9 Pin Characteristics for 80-Pin Package (Continued)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART Pin	Multi-master I^2C bus Pin	Analog Pin
41		$P6_2$				RxD_0		
42		$P6_1$				CLK_0		
43		$P6_0$				$\overline{RTS_0}$ / $\overline{CTS_0}$		
44		$P2_7$			$OUTC1_7$ / $INPC1_7$			
45		$P2_6$			$OUTC1_6$ / $INPC1_6$			
46		$P2_5$			$OUTC1_5$ / $INPC1_5$			
47		$P2_4$			$OUTC1_4$ / $INPC1_4$			
48		$P2_3$			$OUTC1_3$ / $INPC1_3$			
49		$P2_2$			$OUTC1_2$ / $INPC1_2$			
50		$P2_1$			$OUTC1_1$ / $INPC1_1$		SCL_{MM}	
51		$P2_0$			$OUTC1_0$ / $INPC1_0$		SDA_{MM}	
52		$P1_7$	$\overline{INT_5}$	IDU	$INPC1_7$			
53		$P1_6$	$\overline{INT_4}$	IDW				
54		$P1_5$	$\overline{INT_3}$	IDV				$\overline{ADTRG}$
55		$P1_4$						
56		$P1_3$						$AN2_3$
57		$P1_2$						$AN2_2$
58		$P1_1$						$AN2_1$
59		$P1_0$						$AN2_0$
60		$P0_7$						$AN0_7$
61		$P0_6$						$AN0_6$
62		$P0_5$						$AN0_5$
63		$P0_4$						$AN0_4$
64		$P0_3$						$AN0_3$
65		$P0_2$						$AN0_2$
66		$P0_1$						$AN0_1$
67		$P0_0$						$AN0_0$
68		$P10_7$	$\overline{KI_3}$					AN_7
69		$P10_6$	$\overline{KI_2}$					AN_6
70		$P10_5$	$\overline{KI_1}$					AN_5
71		$P10_4$	$\overline{KI_0}$					AN_4
72		$P10_3$						AN_3
73		$P10_2$						AN_2
74		$P10_1$						AN_1
75	AVss							
76		$P10_0$						AN_0
77	V_{REF}							
78	AVcc							
79		$P9_7$				SIN_4		$AN2_7$
80		$P9_6$				$SOUT_4$		$AN2_6$



NOTES:
1. Set PACR2 to PACR0 bit in the PACR register to "010₂" before you input and output it after resetting to each pin. When the PACR register isn't set up, the input and output function of some of the pins are disabled.

Package: PLQP0064KB-A(64P6Q-A)

Figure 1.6 Pin Assignment (Top View) of 64-Pin Package

Table 1.10 Pin Characteristics for 64-Pin Package

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART Pin	Mult-master I^2C bus Pin	Analog Pin
1		$P9_1$		TA_{1IN}				
2		$P9_0$		TB_{0IN}				
3	CNVss							
4	X_{CIN}	$P8_7$						
5	X_{COUT}	$P8_6$						
6	$\overline{RESET}$							
7	X_{OUT}							
8	Vss							
9	X_{IN}							
10	Vcc							
11		$P8_5$	$\overline{NMI}$	$\overline{SD}$				
12		$P8_4$	$\overline{INT_2}$	ZP				
13		$P8_3$	$\overline{INT_1}$					
14		$P8_2$	$\overline{INT_0}$					
15		$P8_1$		TA_{4IN} / $\overline{U}$				
16		$P8_0$		TA_{4OUT} / U				
17		$P7_7$		TA_{3IN}				
18		$P7_6$		TA_{3OUT}				
19		$P7_5$		TA_{2IN} / $\overline{W}$				
20		$P7_4$		TA_{2OUT} / W				
21		$P7_3$		TA_{1IN} / $\overline{V}$		$\overline{CTS_2}$ / $\overline{RTS_2}$ / TxD_1		
22		$P7_2$		TA_{1OUT} / V		CLK_2 / RxD_1		
23		$P7_1$		TA_{0IN}		RxD_2 / SCL_2 / CLK_1		
24		$P7_0$		TA_{0OUT}		TxD_2 / SDA_2 / $\overline{RTS_1}$ / $\overline{CTS_1}$ / $\overline{CTS_0}$ / $CLKS_1$		
25		$P6_7$				TxD_1		
26		$P6_6$				RxD_1		
27		$P6_5$				CLK_1		
28		$P6_4$				$\overline{RTS_1}$ / $\overline{CTS_1}$/ $\overline{CTS_0}$ / $CLKS_1$		
29		$P3_3$						
30		$P3_2$				$SOUT_3$		
31		$P3_1$				SIN_3		
32		$P3_0$				CLK_3		
33		$P6_3$				TxD_0		
34		$P6_2$				RxD_0		
35		$P6_1$				CLK_0		
36		$P6_0$				$\overline{RTS_0}$ / $\overline{CTS_0}$		
37		$P2_7$			$OUTC1_7$ / $INPC1_7$			
38		$P2_6$			$OUTC1_6$ / $INPC1_6$			
39		$P2_5$			$OUTC1_5$ / $INPC1_5$			
40		$P2_4$			$OUTC1_4$ / $INPC1_4$			

Table 10 Pin Characteristics for 64-Pin Package (Continued)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART Pin	Multi-master I^2C bus Pin	Analog Pin
41		$P2_3$			$OUTC1_3$ / $INPC1_3$			
42		$P2_2$			$OUTC1_2$ / $INPC1_2$			
43		$P2_1$			$OUTC1_1$ / $INPC1_1$		SCL_{MM}	
44		$P2_0$			$OUTC1_0$ / $INPC1_0$		SDA_{MM}	
45		$P1_7$	$\overline{INT}_5$	IDU	$INPC1_7$			
46		$P1_6$	$\overline{INT}_4$	IDW				
47		$P1_5$	$\overline{INT}_3$	IDV				$\overline{AD_{TRG}}$
48		$P0_3$						$AN0_3$
49		$P0_2$						$AN0_2$
50		$P0_1$						$AN0_1$
51		$P0_0$						$AN0_0$
52		$P10_7$	$\overline{KI}_3$					AN_7
53		$P10_6$	$\overline{KI}_2$					AN_6
54		$P10_5$	$\overline{KI}_1$					AN_5
55		$P10_4$	$\overline{KI}_0$					AN_4
56		$P10_3$						AN_3
57		$P10_2$						AN_2
58		$P10_1$						AN_1
59	AVss							
60		$P10_0$						AN_0
61	V_{REF}							
62	AVcc							
63		$P9_3$						$AN2_4$
64		$P9_2$		TB_{2IN}				

Table 1.10 Pin Description (64-Pin, 80-Pin and 85-Pin Packages) (Continued)

Classification	Symbol	I/O Type	Function
Timer S	$INPC1_0$ to $INPC1_7$	I	Input pins for the time measurement function
	$OUTC1_0$ to $OUTC1_7$	O	Output pins for the waveform generating function
I/O Ports	$P0_0$ to $P0_3$ $P1_5$ to $P1_7$ $P2_0$ to $P2_7$ $P3_0$ to $P3_3$ $P6_0$ to $P6_7$ $P7_0$ to $P7_7$ $P8_0$ to $P8_7$ $P10_0$ to $P10_7$	I/O	I/O ports for CMOS. Each port can be programmed for input or output under the control of the direction register. An input port can be set, by program, for a pull-up resistor available or for no pull-up resister available in 4-bit units
	$P9_0$ to $P9_3$	I/O	I/O ports having equivalent functions to P0

I : Input O : Output I/O : Input and output

Table 1.10 Pin Description (80-Pin and 85-Pin Packages only) (Continued)

Classification	Symbol	I/O Type	Function
Serial I/O	CLK4	I/O	Inputs and outputs the transfer clock
	SIN4	I	Inputs serial data
	SOUT4	O	Outputs serial data
A/D Converter	AN04 to AN07 AN20 to AN23 AN25 to AN27	I	Analog input pins for the A/D converter
I/O Ports	P04 to P07 P10 to P14 P34 to P37	I/O	I/O ports for CMOS. Each port can be programmed for input or output under the control of the direction register. An input port can be set, by program, for a pull-up resistor available or for no pull-up resister available in 4-bit units
	P95 to P97	I/O	I/O ports having equivalent functions to P0

I : Input O : Output I/O : Input and output

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU registers. The register bank is comprised of 7 registers (R0, R1, R2, R3, A0, A1 and FB) out of 13 CPU registers. Two sets of register banks are provided.

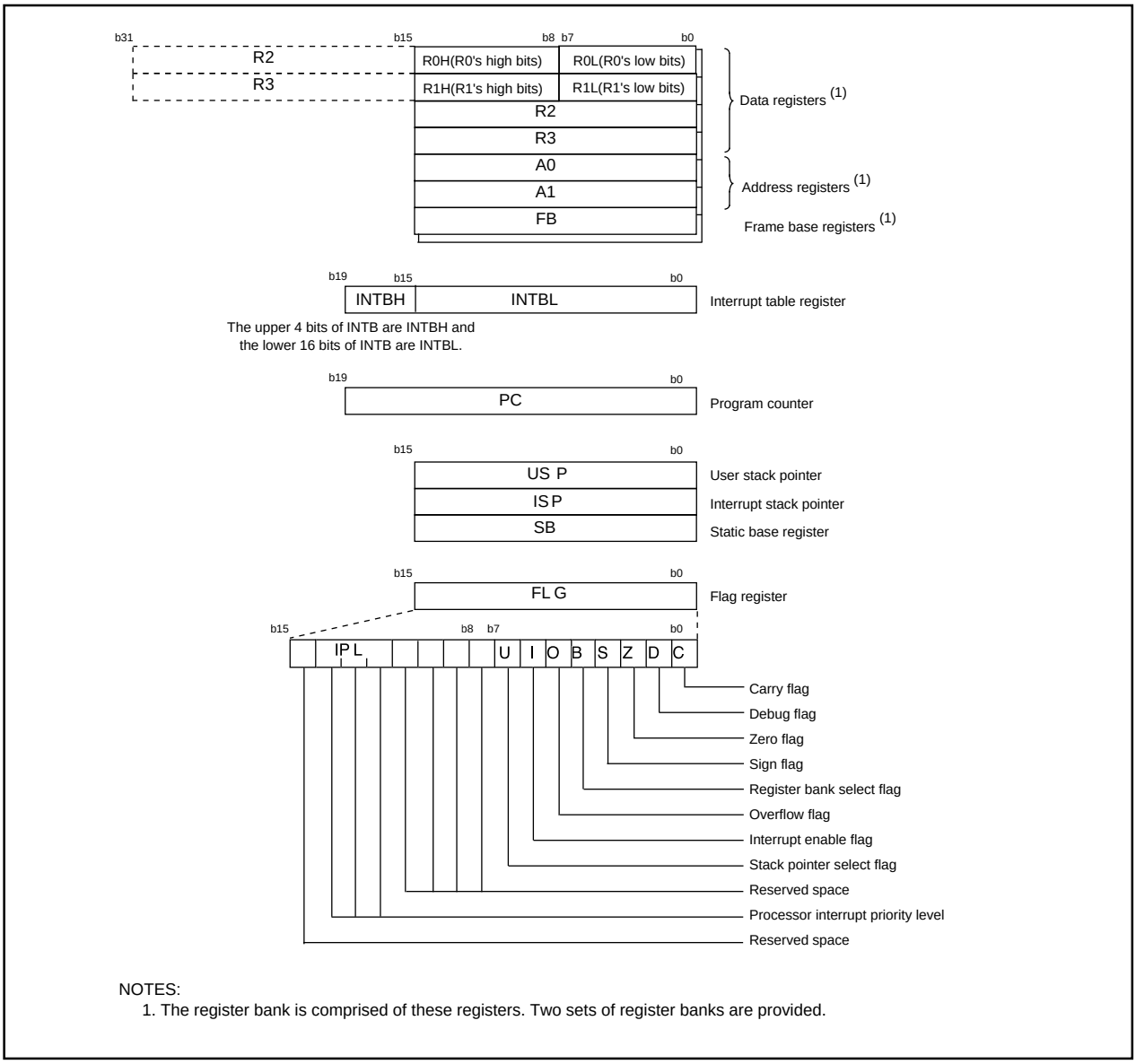


Figure 2.1 Central Processing Unit Register

2.1 Data Registers (R0, R1, R2 and R3)

The R0, R1, R2 and R3 registers are 16 bit registers for transfer and arithmetic/logic operations.

The R0 and R1 registers can be split into high-order bits(R0H, R1H) and low-order bits (R0L, R1L) to be used seperately as 8-bit data registers. Conversely, R2 and R0 can be combined with R2 to be used as a 32-bit data register (R2R0). The same applies to R1 and R2.

2.2 Address Registers (A0 and A1)

The register A0 consists of 16 bits, and is used for address register indirect addressing and address register relative addressing. They also are used for transfers and arithmetic/logic operations. A1 is the same as A0. In some instructions, registers A1 and A0 can be combined for use as a 32-bit address register (A1A0).

2.3 Frame Base Register (FB)

FB is configured with 16 bits, and is used for FB relative addressing.

2.4 Interrupt Table Register (INTB)

INTB is configured with 20 bits, indicating the start address of an interrupt vector table.

2.5 Program Counter (PC)

PC is configured with 20 bits, indicating the address of an instruction to be executed.

2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

Stack pointer (SP) comes in two types: USP and ISP, each configured with 16 bits.

Your desired type of stack pointer (USP or ISP) can be selected by the U flag of FLG.

2.7 Static Base Register (SB)

SB is configured with 16 bits, and is used for SB relative addressing.

2.8 Flag Register (FLG)

FLG consists of 11 bits, indicating the CPU status.

2.8.1 Carry Flag (C Flag)

This flag retains a carry, borrow, or shift-out bit that has occurred in the arithmetic/logic unit.

2.8.2 Debug Flag (D Flag)

The D flag is used exclusively for debugging purpose. During normal use, it must be set to 0.

2.8.3 Zero Flag (Z Flag)

This flag is set to 1 when an arithmetic operation resulted in 0; otherwise, it is 0.

2.8.4 Sign Flag (S Flag)

This flag is set to 1 when an arithmetic operation resulted in a negative value; otherwise, it is 0.

2.8.5 Register Bank Select Flag (B Flag)

Register bank 0 is selected when this flag is 0 ; register bank 1 is selected when this flag is 1.

2.8.6 Overflow Flag (O Flag)

This flag is set to 1 when the operation resulted in an overflow; otherwise, it is 0.

2.8.7 Interrupt Enable Flag (I Flag)

This flag enables a maskable interrupt.

Maskable interrupts are disabled when the I flag is 0, and are enabled when the I flag is 1. The I flag is cleared to 0 when the interrupt request is accepted.

2.8.8 Stack Pointer Select Flag (U Flag)

ISP is selected when the U flag is 0; USP is selected when the U flag is 1.

The U flag is cleared to 0 when a hardware interrupt request is accepted or an INT instruction for software interrupt Nos. 0 to 31 is executed.

2.8.9 Processor Interrupt Priority Level (IPL)

IPL is configured with three bits, for specification of up to eight processor interrupt priority levels from level 0 to level 7.

If a requested interrupt has priority greater than IPL, the interrupt is enabled.

2.8.10 Reserved Area

When write to this bit, write 0. When read, its content is indeterminate.

3. Memory

Figure 3.1 is a memory map of the M16C/28 Group (M16C/28, M16C/28B). M16C/28 Group provides 1-Mbyte address space from addresses 00000$_{16}$ to FFFFF$_{16}$. The internal ROM is allocated lower addresses beginning with address FFFFF$_{16}$. For example, 64 Kbytes internal ROM is allocated addresses F0000$_{16}$ to FFFFF$_{16}$.

Two 2-Kbyte internal ROM areas, block A and block B, are available in the flash memory version. The blocks are allocated addresses F000$_{16}$ to FFFF$_{16}$.

The fixed interrupt vector tables are allocated addresses FFFDC$_{16}$ to FFFFF$_{16}$. It stores the starting address of each interrupt routine. See the section on interrupts for details.

The internal RAM is allocated higher addresses beginning with address 00400$_{16}$. For example, 4-Kbytes internal RAM is allocated addresses 00400$_{16}$ to 013FF$_{16}$. Besides storing data, it becomes stacks when the subroutine is called or an interrupt is acknowledged.

SFR, consisting of control registers for peripheral functions such as I/O port, A/D converter, serial I/O, timers is allocated addresses 00000$_{16}$ to 003FF$_{16}$. All blank spaces within SFR are reserved and cannot be accessed by users.

The special page vector table is allocated to the addresses FFE00$_{16}$ to FFFDB$_{16}$. This vector is used by the JMPS or JSRS instruction. For details, refer to the ***M16C/60 and M16C/20 Series Software Manual***.

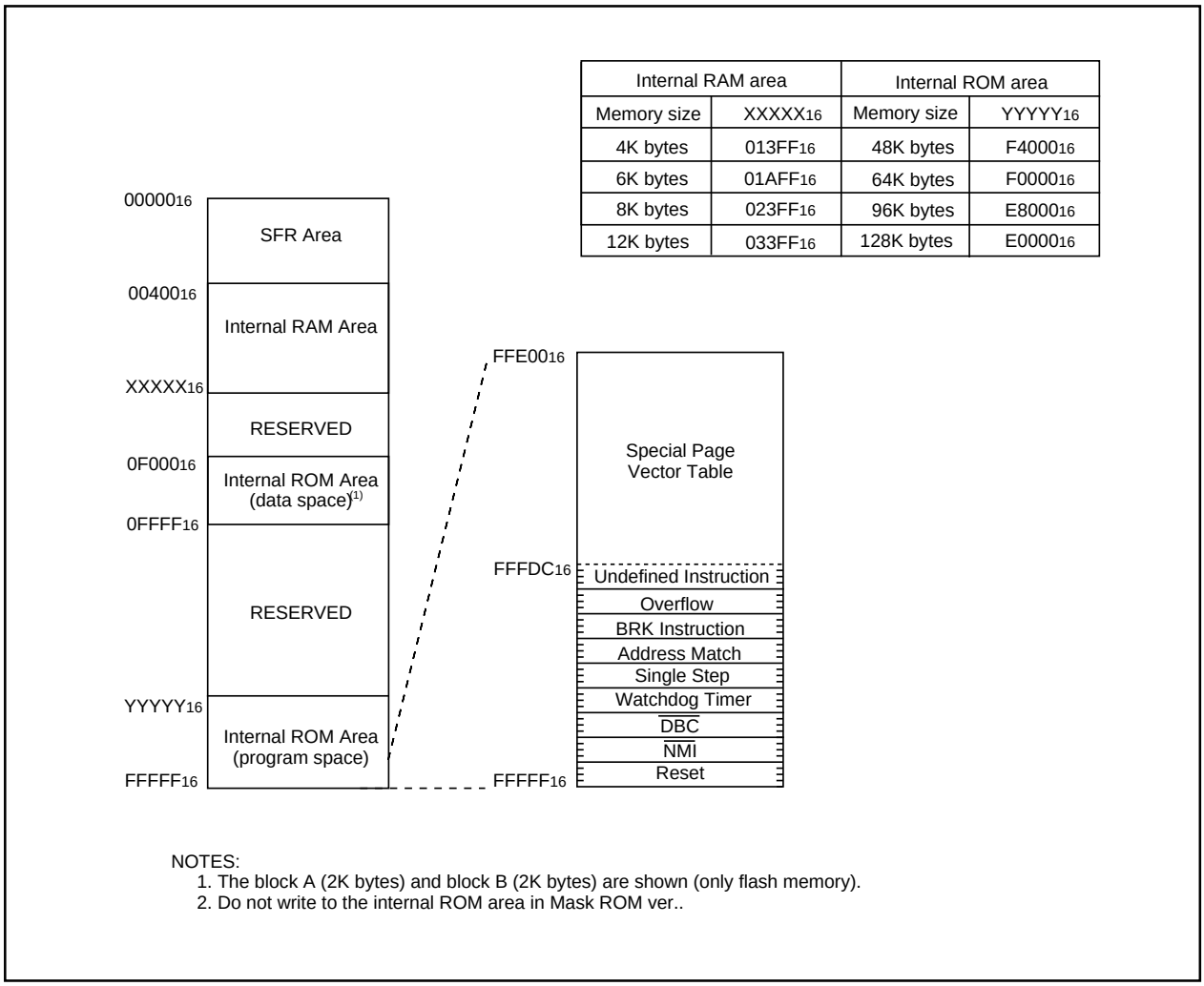


Figure 3.1 Memory Map

Table 4.3 SFR Information(3)(1)

Address	Register	Symbol	After Reset
≈			≈
01B0₁₆			
01B1₁₆			
01B2₁₆			
01B3₁₆	Flash memory control register 4 (2)	FMR4	01000000₂
01B4₁₆			
01B5₁₆	Flash memory control register 1 (2)	FMR1	000XXX0X₂
01B6₁₆			
01B7₁₆	Flash memory control register 0 (2)	FMR0	00000001₂
01B8₁₆			
01B9₁₆			
≈			≈
0210₁₆	Low-power Consumption Control 0	LPCC0	X0000001₂
0211₁₆			
0212₁₆			
0213₁₆			
0214₁₆			
0215₁₆			
0216₁₆			
0217₁₆			
0218₁₆			
0219₁₆			
≈			≈
0250₁₆			
0251₁₆			
0252₁₆			
0253₁₆			
0254₁₆			
0255₁₆			
0256₁₆			
0257₁₆			
0258₁₆			
0259₁₆			
025A₁₆			
025B₁₆			
025C₁₆	On-chip oscillator control register	ROCR	X0000101₂
025D₁₆	Pin assignment control register	PACR	00₁₆
025E₁₆	Peripheral clock select register	PCLKR	00000011₂
025F₁₆	Low-power Consumption Control 1	LPCC1	00₁₆
≈			≈
02E0₁₆	I^2C0 data shift register	S00	XX₁₆
02E1₁₆			
02E2₁₆	I^2C0 address register	S0D0	00₁₆
02E3₁₆	I^2C0 control register 0	S1D0	00₁₆
02E4₁₆	I^2C0 clock control register	S20	00₁₆
02E5₁₆	I^2C0 start/stop condition control register	S2D0	00011010₂
02E6₁₆	I^2C0 control register 1	S3D0	00110000₂
02E7₁₆	I^2C0 control register 2	S4D0	00₁₆
02E8₁₆	I^2C0 status register	S10	0001000X₂
02E9₁₆			
02EA₁₆			
≈			≈
02FE₁₆			
02FF₁₆			

Note 1:The blank spaces are reserved. No access is allowed.
Note 2:This register is included in the flash memory version.

X : Undefined

Table 4.5 SFR Information(5)(1)

Address	Register	Symbol	After Reset
034016			
034116			
034216	Timer A1-1 register	TA11	XX16
034316			XX16
034416	Timer A2-1 register	TA21	XX16
034516			XX16
034616	Timer A4-1 register	TA41	XX16
034716			XX16
034816	Three-phase PWM control register 0	INVC0	0016
034916	Three-phase PWM control register 1	INVC1	0016
034A16	Three-phase output buffer register 0	IDB0	001111112
034B16	Three-phase output buffer register 1	IDB1	001111112
034C16	Dead time timer	DTT	XX16
034D16	Timer B2 interrupt occurrence frequency set counter	ICTB2	XX16
034E16	Position-data-retain function control register	PDRF	XXXX00002
034F16			
035016			
035116			
035216			
035316			
035416			
035516			
035616			
035716			
035816			
035916			
035A16			
035B16			
035C16			
035D16			
035E16	Interrupt request cause select register 2	IFSR2A	00XXXXX02(2)
035F16	Interrupt request cause select register	IFSR	0016
036016	SI/O3 transmit/receive register	S3TRR	XX16
036116			
036216	SI/O3 control register	S3C	010000002
036316	SI/O3 bit rate generator	S3BRG	XX16
036416	SI/O4 transmit/receive register	S4TRR	XX16
036516			
036616	SI/O4 control register	S4C	010000002
036716	SI/O4 bit rate generator	S4BRG	XX16
036816			
036916			
036A16			
036B16			
036C16			
036D16			
036E16			
036F16			
037016			
037116			
037216			
037316			
037416	UART2 special mode register 4	U2SMR4	0016
037516	UART2 special mode register 3	U2SMR3	000X0X0X2
037616	UART2 special mode register 2	U2SMR2	X0000000 2
037716	UART2 special mode register	U2SMR	X0000000 2
037816	UART2 transmit/receive mode register	U2MR	0016
037916	UART2 bit rate generator	U2BRG	XX16
037A16	UART2 transmit buffer register	U2TB	XX16
037B16			XX16
037C16	UART2 transmit/receive control register 0	U2C0	000010002
037D16	UART2 transmit/receive control register 1	U2C1	000000102
037E16	UART2 receive buffer register	U2RB	XX16
037F16			XX16

Note 1: The blank spaces are reserved. No access is allowed.
Note 2: Write 1 to bit 0 after reset.

X : Undefined

Table 4.7 SFR Information(7)(1)

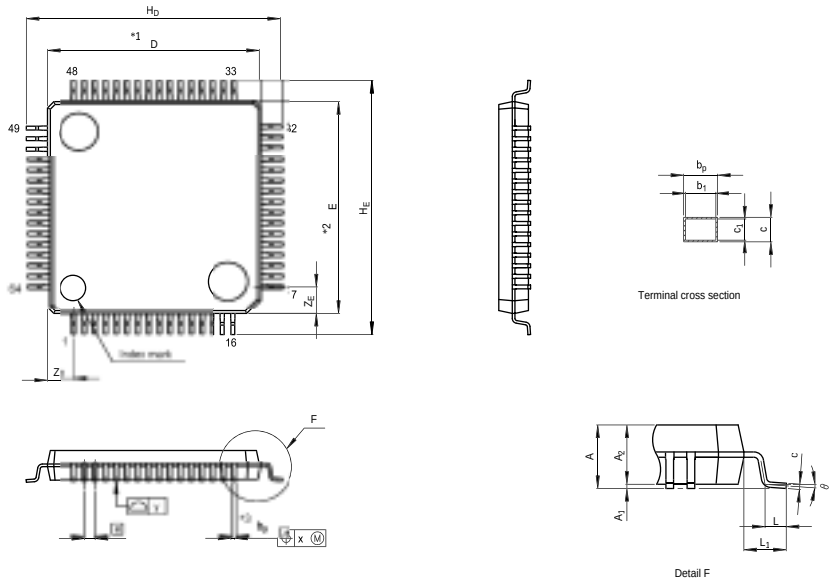
Address	Register	Symbol	After Reset
03C0₁₆	A/D register 0	AD0	XX16
03C1₁₆			XX16
03C2₁₆	A/D register 1	AD1	XX16
03C3₁₆			XX16
03C4₁₆	A/D register 2	AD2	XX16
03C5₁₆			XX16
03C6₁₆	A/D register 3	AD3	XX16
03C7₁₆			XX16
03C8₁₆	A/D register 4	AD4	XX16
03C9₁₆			XX16
03CA₁₆	A/D register 5	AD5	XX16
03CB₁₆			XX16
03CC₁₆	A/D register 6	AD6	XX16
03CD₁₆			XX16
03CE₁₆	A/D register 7	AD7	XX16
03CF₁₆			XX16
03D0₁₆			
03D1₁₆			
03D2₁₆	A/D trigger control register	ADTRGCON	0016
03D3₁₆	A/D convert status register 0	ADSTAT0	00000X002
03D4₁₆	A/D control register 2	ADCON2	0016
03D5₁₆			
03D6₁₆	A/D control register 0	ADCON0	00000XXX2
03D7₁₆	A/D control register 1	ADCON1	0016
03D8₁₆			
03D9₁₆			
03DA₁₆			
03DB₁₆			
03DC₁₆			
03DD₁₆			
03DE₁₆			
03DF₁₆			
03E0₁₆	Port P0 register	P0	XX16
03E1₁₆	Port P1 register	P1	XX16
03E2₁₆	Port P0 direction register	PD0	0016
03E3₁₆	Port P1 direction register	PD1	0016
03E4₁₆	Port P2 register	P2	XX16
03E5₁₆	Port P3 register	P3	XX16
03E6₁₆	Port P2 direction register	PD2	0016
03E7₁₆	Port P3 direction register	PD3	0016
03E8₁₆			
03E9₁₆			
03EA₁₆			
03EB₁₆			
03EC₁₆	Port P6 register	P6	XX16
03ED₁₆	Port P7 register	P7	XX16
03EE₁₆	Port P6 direction register	PD6	0016
03EF₁₆	Port P7 direction register	PD7	0016
03F0₁₆	Port P8 register	P8	XX16
03F1₁₆	Port P9 register	P9	XX16
03F2₁₆	Port P8 direction register	PD8	0016
03F3₁₆	Port P9 direction register	PD9	000X00002
03F4₁₆	Port P10 register	P10	XX16
03F5₁₆			
03F6₁₆	Port P10 direction register	PD10	0016
03F7₁₆			
03F8₁₆			
03F9₁₆			
03FA₁₆			
03FB₁₆			
03FC₁₆	Pull-up control register 0	PUR0	0016
03FD₁₆	Pull-up control register 1	PUR1	0016
03FE₁₆	Pull-up control register 2	PUR2	0016
03FF₁₆	Port control register	PCR	0016

Note 1:The blank spaces are reserved. No access is allowed.

X : Undefined

Appendix 1. Package Dimensions

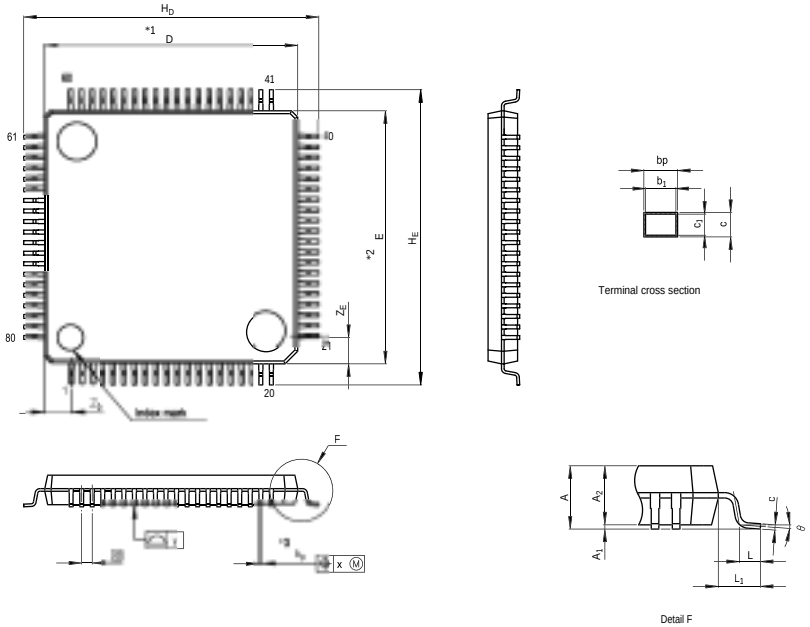
JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LQFP64-10x10-0.50	PLQP0064KB-A	64P6Q-A / FP-64K / FP-64KV	0.3g



NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	9.9	10.0	10.1
E	9.9	10.0	10.1
A_2	—	1.4	—
H_D	11.8	12.0	12.2
H_E	11.8	12.0	12.2
A	—	—	1.7
A_1	0.05	0.1	0.15
b_p	0.15	0.20	0.25
b_1	—	0.18	—
c	0.09	0.145	0.20
c_1	—	0.125	—
θ	0°	—	8°
e	—	0.5	—
x	—	—	0.08
y	—	—	0.08
Z_D	—	1.25	—
Z_E	—	1.25	—
L	0.35	0.5	0.65
L_1	—	1.0	—

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LQFP80-12x12-0.50	PLQP0080KB-A	80P6Q-A	0.5g



NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	11.9	12.0	12.1
E	11.9	12.0	12.1
A_2	—	1.4	—
H_D	13.8	14.0	14.2
H_E	13.8	14.0	14.2
A	—	—	1.7
A_1	0	0.1	0.2
b_p	0.15	0.20	0.25
b_1	—	0.18	—
c	0.09	0.145	0.20
c_1	—	0.125	—
θ	0°	—	10°
e	—	0.5	—
x	—	—	0.08
y	—	—	0.08
Z_D	—	1.25	—
Z_E	—	1.25	—
L	0.3	0.5	0.7
L_1	—	1.0	—